

41. (Amended) A process for the production of a wiring board as claimed in claim 37, wherein:

92 a step for forming said conductive member is effected by forming a nickel (Ni) plating in accordance with electroless plating method.

42. (Amended) A process for the production of a wiring board as claimed in claim 38, wherein:

a step for forming said conductive member is effected by forming a nickel (Ni) plating in accordance with electroless plating method.

REMARKS

Applicants respectfully request that the foregoing amendments be made prior to examination of the present application.

Respectfully submitted,

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